

**■ Productor Character**

- Half Bridge Rectified、Common Cathode Structure.
- Multilayer Metal -Silicon Potential Structure.
- Beautiful High Temperature Character.
- Have Over Voltage protect loop, high reliability.
- RoHs Product.

**■ Primary Use**

- Low Voltage High Frequency Switching Power Supply.
- Low Voltage High Frequency Invers Circuit.
- Low Voltage Continued Circuit and Protection Circuit.

**■ Summarize**

SR2045CS Device optimized for ultra-low forward voltage drop to maximize efficiency in Power Supply applications

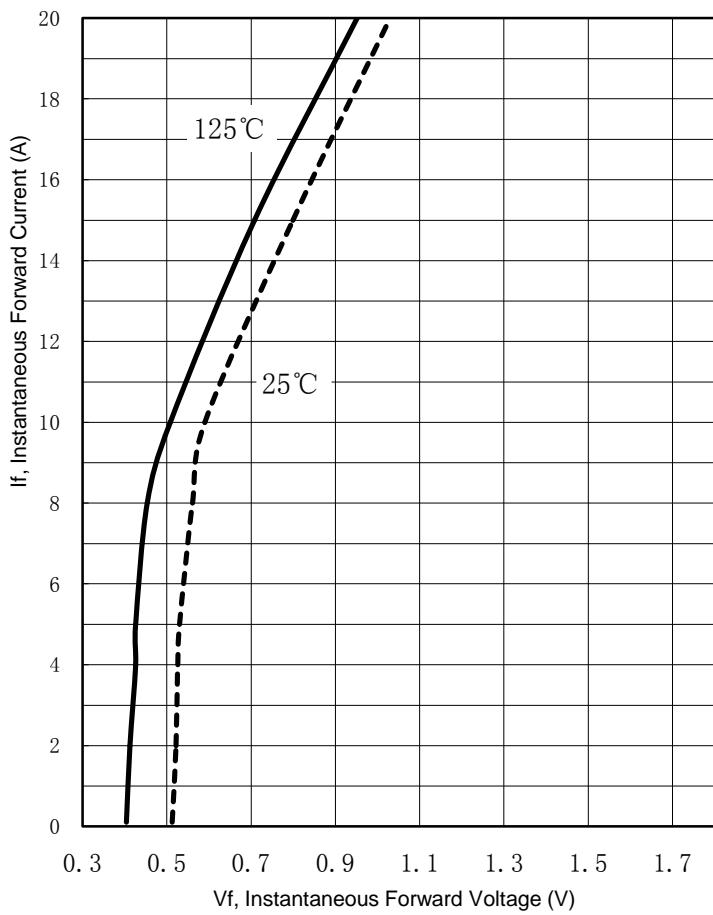
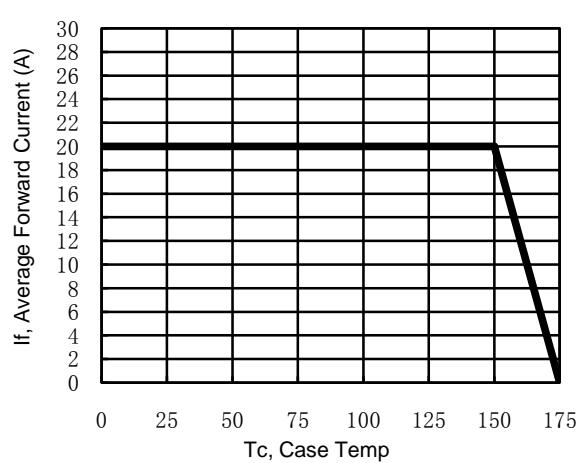
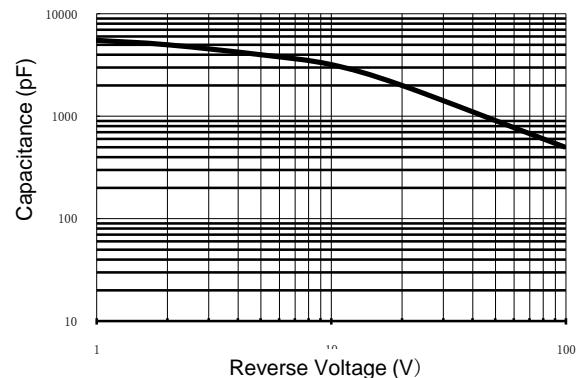
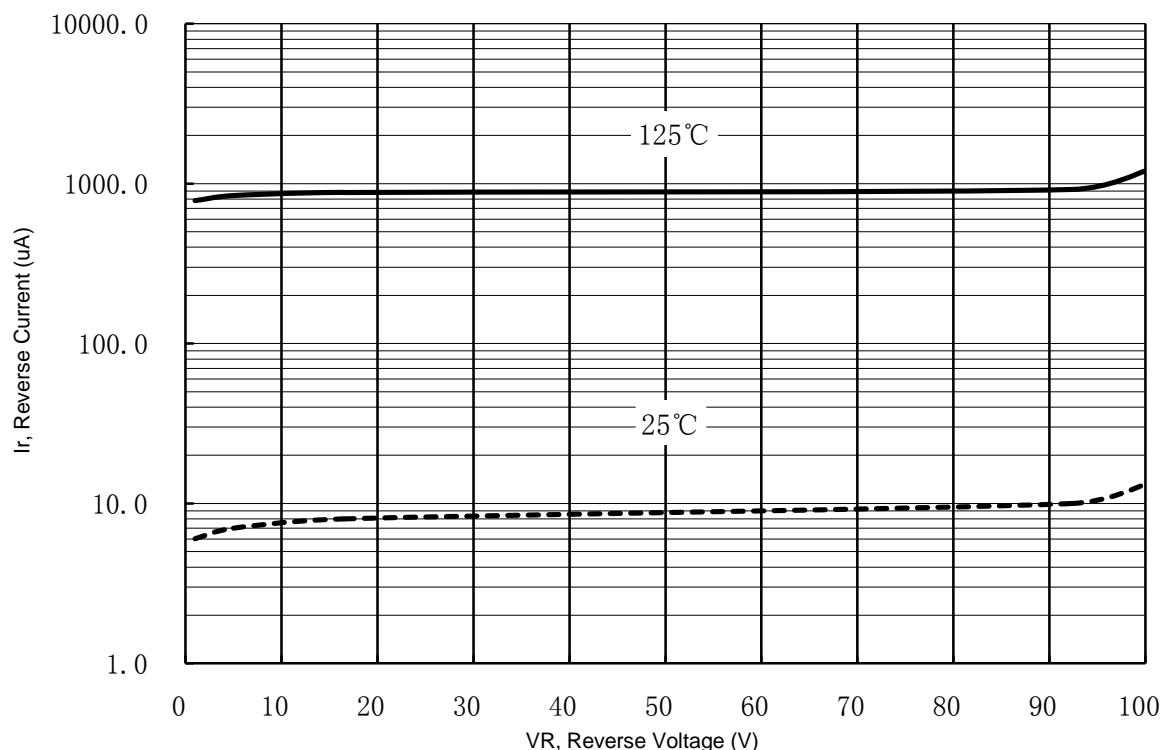
**Absolute Maximum Ratings**

Item	Symbol	Data	Unit
Maximal Inverted Repetitive Peak Voltage	VRRM	45	V
*Average Rectified Forward Current (Rated VR-20Khz Square Wave) - 50% duty cycle	IFAV	20	A
Typical Thermal Resistance (per leg)	R <sub>θJC</sub>	2	°C/W
		4	°C/W
Forward Peak Surge Current(Rated Load 8.3 Half MSSine Wave-According to JEDEC Method)	IFSM	150	A
Maximum Rate of Voltage Change ( at Rated VR )	dv/dt	10000	V/uS
Peak Repetitive Reverse Surge Current (2uS-1Khz)	IRRM	1	A
Operating Junction Temperature	TJ	-40- +175	°C
Storage Temperature	TSTG	-40- +175	°C

**Electricity Character**

Item	Test Condition		TYP.	MAX.	Unit
IR	TJ =25°C	VR=VRRM		10	uA
	TJ =125°C			1	mA
VF	TJ =25°C	IF=10A		0.65	V
	TJ =125°C	IF=10A	0.48	0.51	V

\*IF(AV)= 10Ax2

**The forward voltage and forward current curve.****Current Derating Curve, Per Element****The crunode capacitance curve****The reverse leak current and the reverse voltage (single-device) curve.**

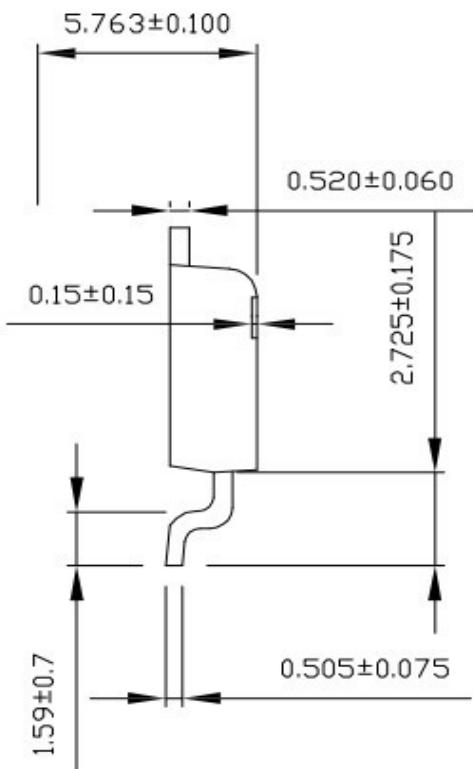
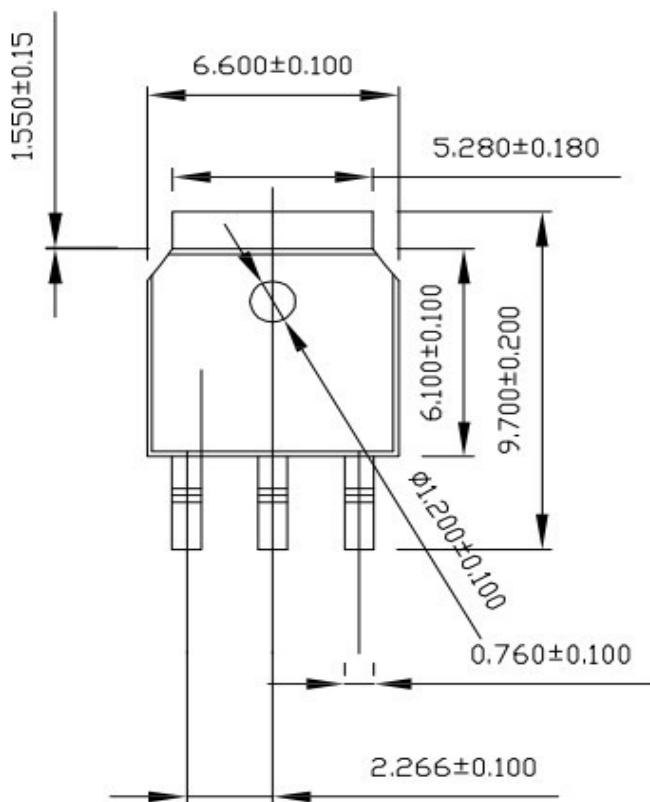
MHCHXM

# High-Voltage Schottky Diodes

SR 2045CS

## Package Outline Dimensions millimeters

TO-252



## Ordering information

MHCHXM

SR2045CS

XXXX

- 1.XXXX代表日期码，第一码表示公元年的最后一码，第二码表示生产时当月码（A,B,C .为一月，二月，三月 ），第三，四码表示大量生产时批次码。  
例如:2009年第一月生产的，D/C为9AXX。
- 2.包装及出货:ROHS,50PCS/管,1K/BOX,5K(5K BOXEX)/CARTON, BOXEX及CARTON。
- 3.ITO-220封装后面加“F”区别。

### 注意事项

- 1) 凡本公司出厂的产品，均符合相应规格书的电参数和外形尺寸要求；对于客户有特殊要求的产品，双方应签订相关技术协议。
- 2) 在安装时，要注意减少机械应力的产生，防止由此引起的产品失效；避免靠近发热元件；焊接上锡时要注意控制温度和时间。